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		Attorney D	ocket No. <u>450100-04985</u>
App	plicants:	Kenichi NAKANISHI, Junko S KANEKO, Osamu NAGATA,	
For	:	DATA STORAGE DEVICE, MANAGEMENT INFORMAT STORAGE DEVICE, AND CO	TION IN A DATA
U.S	S. Serial No.:	Filed Concurrently Herewith	
Corresponding International Application. No.:		PCT/JP04/002924	
International Filing Date:		March 5, 2004	
Cor P.C	il Stop PCT nmissioner for Patents D. Box 1450 xandria, VA 22313-1450		
<u>į</u> .	Names of Conveying Parties:	Kenichi NAKANISHI, Junko S KANEKO, Osamu NAGATA,	
2.	Names and addresses of receiving parties:	SONY CORPORATION 7-35 Kitashinagawa 6-chome Shinagawa-Ku, Tokyo 141-0001, Japan	
3.	Nature of Conveyance: Execution Date(s): Assignment October 12, October 12, October 14 and October 12, 2004		er 12, October 14 and October
4.	 ☐ Application No.: ☑ This document is being filed together with a new application, the execution date of the application is: October 12, October 12, October 14 and October 12, 2004 		
5.			
		William S. Frommer Registration No. 25,506 FROMMER LAWRENCE & F 745 Fifth Avenue New York, New York 10151	HAUG LLP
6.	Total number of applications and patents involved: 1		
7.	Total Fee (37 CFR 3.41): ☑ Fee enclosed.	<u>\$40.00</u>	
8.	Charge Fee Deposit Account No. 50-0320 (Attach duplicate copy of this page if paying by deposit account).		
	☐ If any additional fee is required, authoriza	ation is hereby given to charge D	eposit Account No. 50-0320.
9.	Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.		correct and any attached
	William S. Frommer Will	can frommen	November 18, 2004
	Name of Person Signing	Signature 1	Date

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PATENT REEL: 016455 FRAME: 0400

CMS Docket Number: 450100-04985

S04P0347US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in DATA STORAGE DEVICE, METHOD OF UPDATING MANAGEMENT INFORMATION IN A DATA STORAGE DEVICE, AND COMPUTER PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: International Application No.: FCF/JP2004/002924, International Filing Date: March 5, 2004

This assignment executed on the dates indicated below.

Kenichi NAKANISHI

Name of first or sole inventor Tokyo, Japan	Execution date of U.S. Patent Application	
Residence of first or sole inventor Kenichi Nakanishi	12 Oct, 2004	
Signature of first or sole inventor	Date of this assignment	
Junko SASAKI		
Name of second inventor Tokyo, Japan	Execution date of U.S. Patent Application	
Residence of second inventor Sasaki	12.0d,2004	
Signature of second inventor	Date of this assignment	
Nobuhiro KANEKO		
Name of third inventor Kanagawa, Japan	Execution date of U.S. Patent Application	
Residence of third inventor		
Nobuhito Kaneko	12, Oct, 2004	
gnature of third inventor Date of this assignment		

ADDITIONAL INVENTOR(S) ON NEXT PAGE

PATENT REEL: 016455 FRAME: 0401

Osamu NAGATA	
Name of fourth inventor Aichi, Japan	Execution date of U.S. Patent Application
Residence of fourth inventor	
Osamu hagata	14. Oct , 2004
Signature of fourth inventor	Date of this assignment
Hideaki OKUBO	·
Name of fifth inventor	Execution date of U.S. Patent Application
Saitama, Japan	
Residence of fifth inventor	/ 0 / 1
Hideaki Okubo	12 Oct, 2004
Signature of fifth inventor	Date of this assignment
Name of sixth inventor	Execution date of U.S. Patent Application
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Residence of sixth inventor	
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Signature of sixth inventor	Date of this assignment
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Signature of seventh inventor	Date of this assignment
Name of eighth inventor	Execution date of U.S. Patent Application
Residence of eighth inventor	·
Signature of eighth inventor	Date of this assignment
Name of ninth inventor	Execution date of U.S. Patent Application
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Residence of ninth inventor	
Signature of ninth inventor	Date of this assignment

PATENT REEL: 016455 FRAME: 0402